Si4090BDY

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SHA

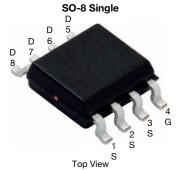
Vishay Siliconix

RoHS

COMPLIANT

HALOGEN

FREE



| TOP VIEw | | | | | |
|---|--------|--|--|--|--|
| PRODUCT SUMMARY | | | | | |
| V _{DS} (V) | 100 | | | | |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V | 0.0100 | | | | |
| $R_{DS(on)}$ max. (Ω) at V_GS = 7.5 V | 0.0106 | | | | |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 6 V | 0.0113 | | | | |
| Q _g typ. (nC) | 28 | | | | |
| I _D (A) ^a | 18.7 | | | | |
| Configuration | Single | | | | |

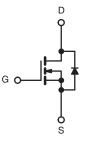
FEATURES

N-Channel 100 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % $\rm R_g$ and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- DC/DC primary side switch
- Telecom / server
- Motor drive control
- Synchronous rectification



N-Channel MOSFET

| ORDERING INFORMATION | | | | |
|----------------------|---------------------------------|------------------|--|--|
| | Package | SO-8 | | |
| | Lead (Pb)-free and halogen-free | SI4090BDY-T1-GE3 | | |

| ABSOLUTE MAXIMUM RATING | iS (T _A = 25 °C, u | Inless otherv | wise noted) | | |
|--|--------------------------------------|-----------------------------------|----------------------|------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Drain-source voltage | | V _{DS} | 100 | V | |
| Gate-source voltage | | V _{GS} | ± 20 | V | |
| | T _C = 25 °C | | 18.7 | | |
| Continuous drain surrent (T 150 °C) | T _C = 70 °C | 1 . | 15 | | |
| Continuous drain current (T _J = 150 °C) | T _A = 25 °C | - I _D | 12.2 ^{b, c} | | |
| | T _A = 70 °C | | 9.8 ^{b, c} | | |
| Pulsed drain current (t = 300 µs) | | I _{DM} | 80 | — A | |
| Continuous source-drain diode current | T _C = 25 °C | - I _S | 6.7 | | |
| | T _A = 25 °C | | 2.8 ^{b, c} | | |
| Single pulse avalanche current | | I _{AS} | 35 | | |
| Avalanche energy | L = 0.1 mH | E _{AS} | 61.25 | mJ | |
| Maximum power dissipation | T _C = 25 °C | | 7.4 | | |
| | T _C = 70 °C | 1 _ | 4.7 | | |
| | T _A = 25 °C | P _D | 3.1 ^{b, c} | W | |
| | T _A = 70 °C | 1 | 2.0 ^{b, c} | | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------------|--------------|-------------------|---------|---------|------|--|
| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT | |
| Maximum junction-to-ambient b, d | t ≤ 10 s | R _{thJA} | 33 | 40 | °C/W | |
| Maximum junction-to-foot (drain) | Steady state | R _{thJF} | 15 | 17 | | |

Notes

a. Based on $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 90 °C/W

S21-0072-Rev. A, 08-Feb-2021

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| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|---|-------------------------|---|------|--------|--------|-------|--|
| Static | | | | | | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 V, I_D = 250 \mu A$ | 100 | - | - | V | |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 10 mA | - | 70 | - | | |
| V _{GS(th)} temperature coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | - | -7.6 | - | mV/°C | |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 2 | - | 4 | V | |
| Gate-source leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | - | - | ± 100 | nA | |
| Zerrente aller duite entret | | V _{DS} = 100 V, V _{GS} = 0 V | - | - | 1 | μA | |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 55 °C | - | - | 10 | | |
| On-state drain current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$ | 20 | - | - | А | |
| | | V _{GS} = 10 V, I _D = 12.2 A | - | 0.0084 | 0.0100 | | |
| Drain-source on-state resistance ^a | R _{DS(on)} | V _{GS} = 7.5 V, I _D = 11.8 A | - | 0.0088 | 0.0106 | Ω | |
| | | V _{GS} = 6 V, I _D = 11.5 A | - | 0.0094 | 0.0113 | | |
| Forward transconductance ^a | g _{fs} | V _{DS} = 15 V, I _D = 12.2 A | - | 98 | - | S | |
| Dynamic ^b | | • | • | | • | | |
| Input capacitance | C _{iss} | | - | 3570 | - | pF | |
| Output capacitance | Coss | V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz | - | 250 | - | | |
| Reverse transfer capacitance | C _{rss} | | - | 10 | - | | |
| Tababaalaalaa | 0 | V _{DS} = 50 V, V _{GS} = 10 V, I _D = 12.2 A - | - | 46.5 | 70 | | |
| Total gate charge | Qg | | - | 28 | 42 | nC | |
| Gate-source charge | Q _{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 6 \text{ V}, I_{D} = 12.2 \text{ A}$ | - | 17 | - | | |
| Gate-drain charge | Q _{gd} | | - | 5 | - | | |
| Gate resistance | R _g | f = 1 MHz | 0.12 | 0.6 | 1.2 | Ω | |
| Turn-on delay time | t _{d(on)} | | - | 18 | 36 | | |
| Rise time | t _r | $V_{DD} = 50 \text{ V}, \text{ R}_1 = 5 \Omega$ | - | 6 | 12 | | |
| Turn-off delay time | t _{d(off)} | $I_D \cong 10$ Å, $V_{GEN} = 7.5$ V, $R_g = 1 \Omega$ | - | 30 | 60 | | |
| Fall time | t _f | | - | 8 | 16 | | |
| Turn-on delay time | t _{d(on)} | | - | 22 | 44 | ns | |
| Rise time | t _r | $V_{DD} = 50 \text{ V}, \text{ R}_{\text{I}} = 5 \Omega$ | - | 8 | 16 | 1 | |
| Turn-off delay time | t _{d(off)} | $I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ Ω | - | 32 | 64 | | |
| Fall time | t _f | | - | 10 | 20 | | |
| Drain-source Body Diode Characteristi | cs | • | • | | • | | |
| Continuous source-drain diode current | I _S | T _C = 25 °C | - | - | 7 | | |
| Pulse diode forward current ^a | I _{SM} | | - | - | 70 | 70 A | |
| Body diode voltage | V _{SD} | I _S = 5 A | - | 0.75 | 1.1 | V | |
| Body diode reverse recovery time | t _{rr} | | - | 44 | 88 | ns | |
| Body diode reverse recovery charge | Q _{rr} | I _F = 10 A, di/dt = 100 A/μs, | - | 90 | 180 | nC | |
| Reverse recovery fall time | t _a | $T_{\rm J} = 25 ^{\circ}{\rm C}$ | - | 37 | - | | |
| Reverse recovery rise time | t _b | 1 | - | 7 | - | ns | |

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

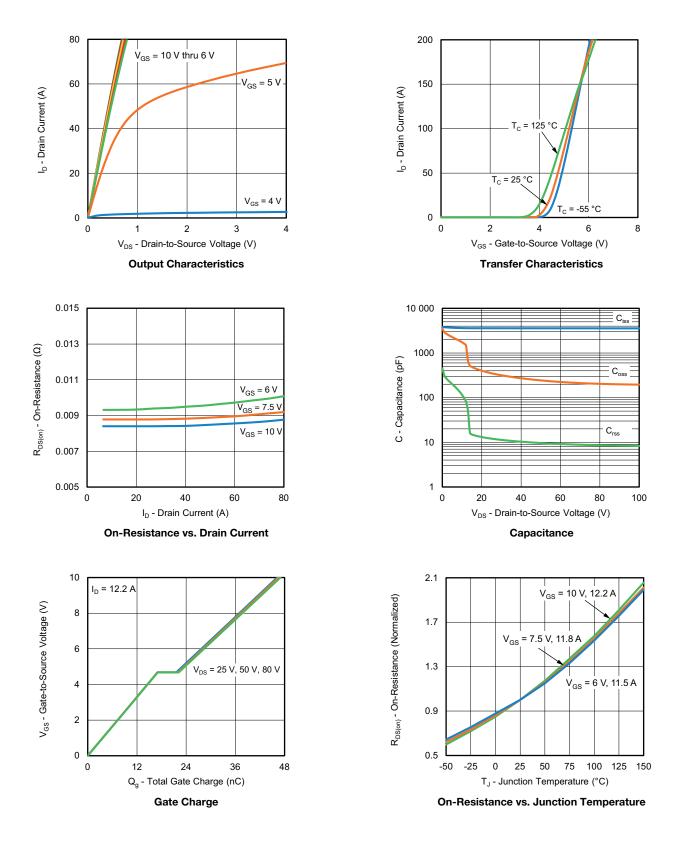
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

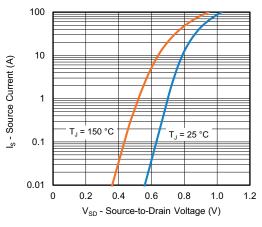




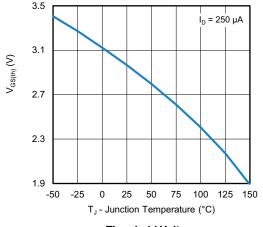
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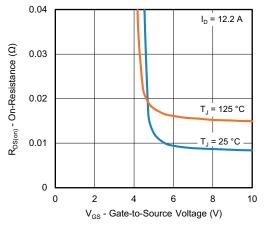
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



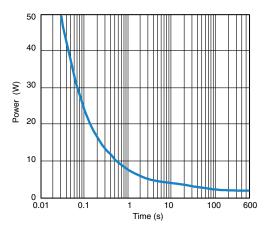
Source-Drain Diode Forward Voltage



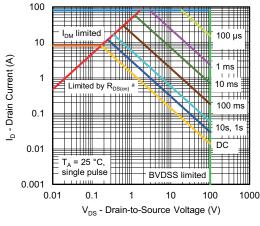




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

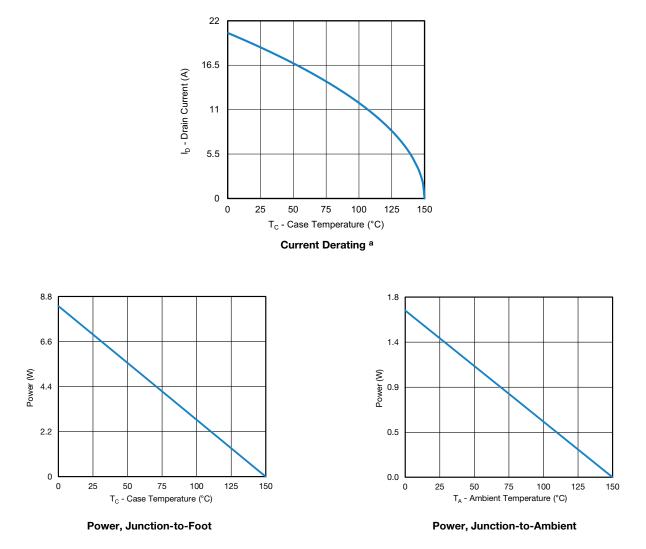
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



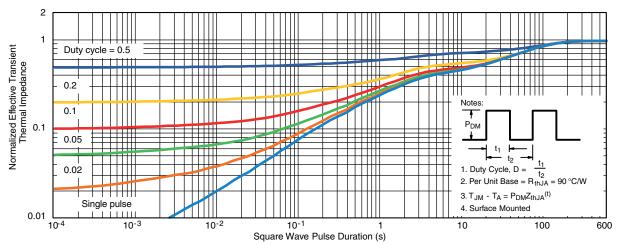
S21-0072-Rev. A, 08-Feb-2021

Si4090BDY

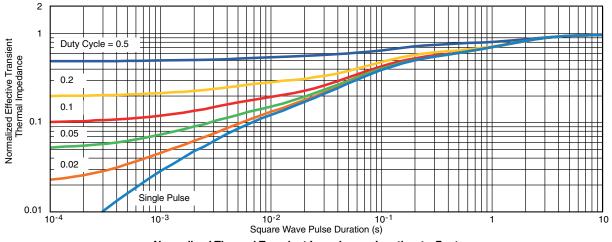
Vishay Siliconix

Document Number: 63035

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63035.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





| | MILLIM | IETERS | INC | INCHES | | |
|---|--------|--------|-----------|--------|--|--|
| DIM | Min | Мах | Min | Max | | |
| A | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| E | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC | 0.050 BSC | | | |
| н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498 | | | | | | |

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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